

vPolyTan™ Polymer Surface Mount Chip Capacitors, Compact, Leadframeless Molded Type



FEATURES

- Low ESR
- 100 % surge current tested
- Molded case available in 8 case codes including 0603 and 0805 footprint
- Lead (Pb)-free L-shaped face-down terminations
- 8 mm tape and reel packaging available per EIA-481 standard
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

PERFORMANCE / ELECTRICAL CHARACTERISTICS

Operating Temperature: -55 °C to +105 °C
Capacitance Range: 1 µF to 330 µF
Capacitance Tolerance: ± 20 %
Voltage Rating: 6.3 V_{DC} to 35 V_{DC}

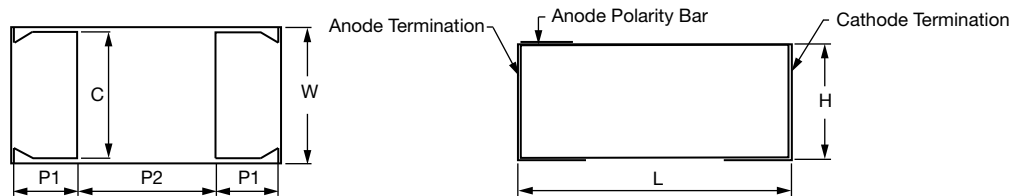
APPLICATIONS

- Decoupling, smoothing, filtering
- Bulk energy storage in wireless cards
- Infrastructure equipment
- Storage and networking
- Computer motherboards
- Smartphones and tablets

ORDERING INFORMATION

| T58 TYPE | MM CASE CODE | 106 CAPACITANCE | M CAPACITANCE TOLERANCE | 6R3 DC VOLTAGE RATING | C TERMINATION / PACKAGING | 0300 ESR |
|-------------|-----------------------------------|--|-------------------------------|---|--|---------------------------|
| | See Ratings and Case Codes table. | This is expressed in picofarads. The first two digits are the significant figures. The third is the number of zeros to follow. | M = ± 20 % | This is expressed in volts. To complete the three-digit block, zeros precede the voltage rating. A decimal point is indicated by an "R" (6R3 = 6.3 V) | C = lead (Pb)-free solderable coating, 7" reel | Maximum 100 kHz ESR in mΩ |

DIMENSIONS in inches [millimeters]



| CASE CODE | EIA SIZE | H (MAX.) | L | W | P1 | P2 (REF.) | C |
|-----------|----------|----------------|------------------------------|-------------------------------|------------------------------|-----------------|------------------------------|
| MM | 1608-09 | 0.035 [0.9] | 0.063 ± 0.008 [1.6 ± 0.2] | 0.033 ± 0.008 [0.85 ± 0.2] | 0.020 ± 0.004 [0.5 ± 0.1] | 0.024 [0.6] | 0.024 ± 0.004 [0.6 ± 0.1] |
| M0 | 1608-10 | 0.039 [1.0] | 0.063 ± 0.008 [1.6 ± 0.2] | 0.033 ± 0.008 [0.85 ± 0.2] | 0.020 ± 0.004 [0.5 ± 0.1] | 0.024 [0.6] | 0.024 ± 0.004 [0.6 ± 0.1] |
| W9 | 2012-09 | 0.035 [0.9] | 0.079 ± 0.008 [2.0 ± 0.2] | 0.049 ± 0.008 [1.25 ± 0.2] | 0.020 ± 0.004 [0.5 ± 0.1] | 0.039 [1.0] | 0.035 ± 0.004 [0.9 ± 0.1] |
| W0 | 2012-10 | 0.039 [1.0] | 0.079 ± 0.008 [2.0 ± 0.2] | 0.049 ± 0.008 [1.25 ± 0.2] | 0.020 ± 0.004 [0.5 ± 0.1] | 0.039 [1.0] | 0.035 ± 0.004 [0.9 ± 0.1] |
| A0 | 3216-10 | 0.039 [1.0] | 0.126 ± 0.008 [3.2 ± 0.2] | 0.063 ± 0.008 [1.6 ± 0.2] | 0.031 ± 0.004 [0.8 ± 0.1] | 0.063 [1.6] | 0.047 ± 0.004 [1.2 ± 0.1] |
| AA | 3216-18 | 0.071 [1.8] | 0.126 ± 0.008 [3.2 ± 0.2] | 0.063 ± 0.008 [1.6 ± 0.2] | 0.031 ± 0.004 [0.8 ± 0.1] | 0.063 [1.6] | 0.047 ± 0.004 [1.2 ± 0.1] |
| B0 | 3528-10 | 0.039 [1.0] | 0.138 ± 0.008 [3.5 ± 0.2] | 0.110 ± 0.008 [2.8 ± 0.2] | 0.031 ± 0.008 [0.8 ± 0.2] | 0.077 [1.95] | 0.094 ± 0.004 [2.4 ± 0.1] |
| BB | 3528-20 | 0.079 [2.0] | 0.138 ± 0.008 [3.5 ± 0.2] | 0.110 ± 0.008 [2.8 ± 0.2] | 0.031 ± 0.008 [0.8 ± 0.2] | 0.077 [1.95] | 0.094 ± 0.004 [2.4 ± 0.1] |

| RATINGS AND CASE CODES (ESR mΩ) | | | | | | |
|--|---------------------------------------|---------------|----------|--------------|---------------|----------|
| μF | 6.3 V | 8.2 V | 10 V | 16 V | 25 V | 35 V |
| 1 | | | | | | W9 (500) |
| 4.7 | | | | | W0 (500) | |
| 10 | MM (300, 500) | | | | | |
| 22 | MM (300, 500) / W9 (500) | | | | BB (100, 150) | |
| 47 | M0 (300, 500) / W9 (150, 200, 300) | W0 (300, 500) | A0 (175) | BB (90, 200) | | |
| 100 | A0 (100, 150) | | | | | |

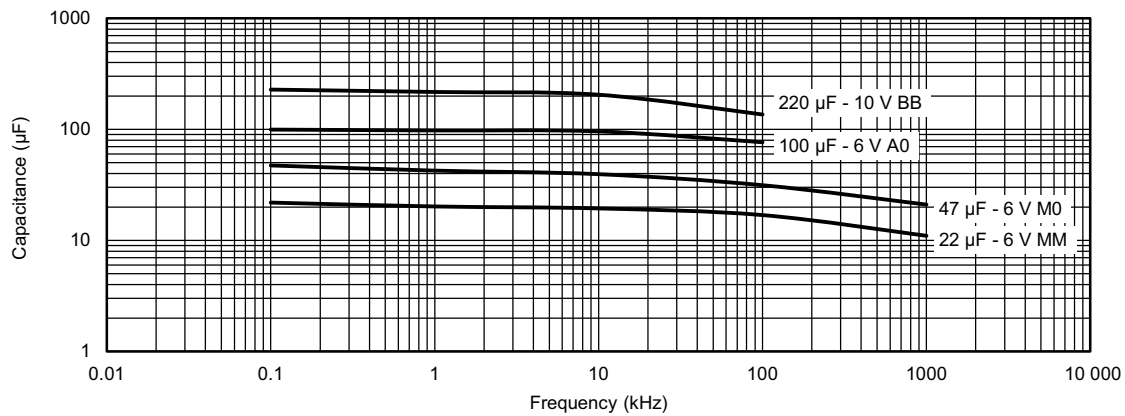
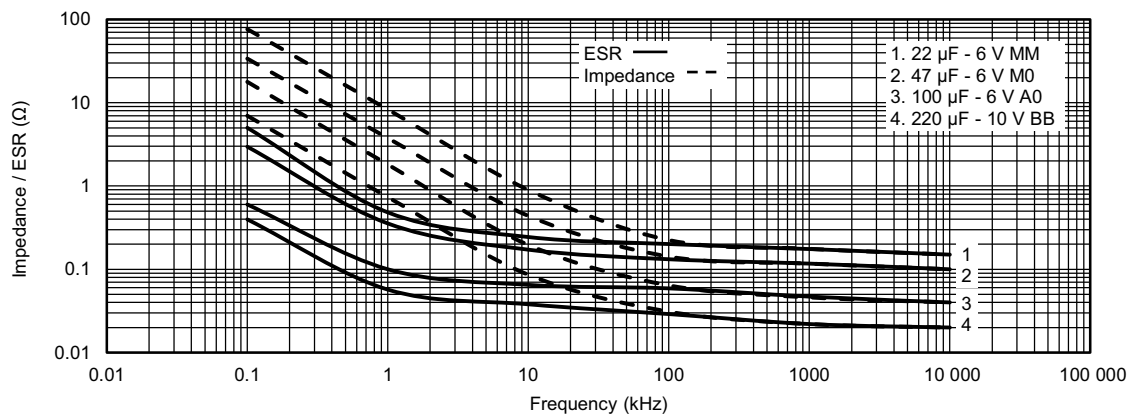
| MARKING | | | |
|-----------------------|------|-------------------------|------|
| <p>Wx-Case</p> | | <p>Mx-Case</p> | |
| <p>Ax-Case</p> | | <p>Bx-Case</p> | |
| VOLTAGE CODE | | CAPACITANCE CODE | |
| V | CODE | CAP, μF | CODE |
| 6.3 | J | 1 | A |
| 8.2 | k | 4.7 | S |
| 10 | A | 10 | α |
| 16 | C | 22 | j |
| 25 | E | 47 | s |
| 35 | V | 100 | Ā |
| | | 150 | Ē |



| STANDARD RATINGS | | | | | | | | | |
|--------------------------------------|-------------------|-------------------|-------------------------------------|---------------------------------------|---|---|-----------------------|-------------|--|
| CAPACITANCE (μ F) | CASE CODE | PART NUMBER | MAX. DCL AT +25 °C (μ A) | MAX. DF AT +25 °C 120 Hz (%) | MAX. ESR AT +25 °C 100 kHz (m Ω) | MAX. RIPPLE, 100 kHz I _{RMS} (A) | HIGH TEMPERATURE LOAD | | |
| | | | | | | | TEMPERATURE (°C) | TIME (h) | |
| 6.3 V_{DC} AT +105 °C | | | | | | | | | |
| 10 | MM | T58MM106M6R3C0500 | 6.3 | 8 | 500 | 0.224 | 105 | 2000 | |
| 10 | MM | T58MM106M6R3C0300 | 6.3 | 8 | 300 | 0.289 | 105 | 2000 | |
| 22 | MM | T58MM226M6R3C0500 | 14 | 10 | 500 | 0.224 | 105 | 2000 | |
| 22 | MM | T58MM226M6R3C0300 | 14 | 10 | 300 | 0.289 | 105 | 2000 | |
| 22 | W9 | T58W9226M6R3C0500 | 14 | 10 | 500 | 0.283 | 105 | 2000 | |
| 47 | M0 ⁽¹⁾ | T58M0476M6R3C0500 | 30 | 14 | 500 | 0.224 | 85 | 2000 | |
| 47 | M0 ⁽¹⁾ | T58M0476M6R3C0300 | 30 | 14 | 300 | 0.289 | 85 | 2000 | |
| 47 | W9 | T58W9476M6R3C0300 | 30 | 10 | 300 | 0.365 | 105 | 1000 | |
| 47 | W9 | T58W9476M6R3C0200 | 30 | 10 | 200 | 0.447 | 105 | 1000 | |
| 47 | W9 | T58W9476M6R3C0150 | 30 | 10 | 150 | 0.516 | 105 | 1000 | |
| 100 | A0 | T58A0107M6R3C0150 | 63 | 10 | 150 | 0.606 | 105 | 1000 | |
| 100 | A0 | T58A0107M6R3C0100 | 63 | 10 | 100 | 0.742 | 105 | 1000 | |
| 8.2 V_{DC} AT +105 °C | | | | | | | | | |
| 47 | W0 | T58W0476M8R2C0500 | 39 | 10 | 500 | 0.283 | 105 | 1000 | |
| 47 | W0 | T58W0476M8R2C0300 | 39 | 10 | 300 | 0.365 | 105 | 1000 | |
| 10 V_{DC} AT +105 °C | | | | | | | | | |
| 47 | A0 | T58A0476M010C0175 | 47 | 14 | 175 | 0.561 | 105 | 1000 | |
| 16 V_{DC} AT +105 °C | | | | | | | | | |
| 47 | BB | T58BB476M016C0200 | 75 | 14 | 200 | 0.652 | 105 | 2000 | |
| 47 | BB | T58BB476M016C0090 | 75 | 14 | 90 | 0.972 | 105 | 2000 | |
| 25 V_{DC} AT +105 °C | | | | | | | | | |
| 4.7 | W0 | T58W0475M025C0500 | 23.5 | 10 | 500 | 0.283 | 105 | 1000 | |
| 22 | BB | T58BB226M025C0150 | 55 | 14 | 150 | 0.753 | 105 | 2000 | |
| 22 | BB | T58BB226M025C0100 | 55 | 14 | 100 | 0.850 | 105 | 2000 | |
| 35 V_{DC} AT +105 °C | | | | | | | | | |
| 1.0 | W9 | T58W9105M035C0500 | 3.5 ⁽²⁾ | 8 | 500 | 0.283 | 105 | 2000 | |

Notes⁽¹⁾ Humidity tests at 40 °C / 90 % RH 500 h, no voltage applied⁽²⁾ Can be rated up to 38 V

| RECOMMENDED VOLTAGE DERATING GUIDELINES | |
|---|-------------------|
| CAPACITOR VOLTAGE RATING | OPERATING VOLTAGE |
| 6.3 | 5.0 |
| 8.2 | 6.6 |
| 10 | 8.0 |
| 16 | 12.8 |
| 25 | 20 |
| 35 | 28 |

CAPACITANCE VS. FREQUENCY

IMPEDANCE AND ESR VS. FREQUENCY

POWER DISSIPATION

| CASE CODE | MAXIMUM PERMISSIBLE POWER DISSIPATION AT +25 °C (W) IN FREE AIR |
|-----------|---|
| MM / M0 | 0.025 |
| W9 / W0 | 0.040 |
| A0 | 0.055 |
| AA | 0.075 |
| B0 | 0.070 |
| BB | 0.085 |



| STANDARD PACKAGING QUANTITY | |
|-----------------------------|-------------------|
| CASE CODE | UNITS PER 7" REEL |
| MM / M0 | 4000 |
| W0 | 3000 |
| W9 | 4000 |
| A0 | 3000 |
| AA | 2000 |
| B0 | 3000 |
| BB | 2000 |

| PERFORMANCE CHARACTERISTICS | | | |
|--|--|--|---|
| ITEM | CONDITION | POST TEST PERFORMANCE | |
| Life test at +105 °C | 2000 h application of rated voltage at 105 °C, MIL-STD-202 method 108 | Capacitance change | Within ± 20 % of initial value |
| | | Dissipation factor | Within initial limits |
| | | Leakage current | Shall not exceed 300 % of initial limit |
| Humidity tests | At 60 °C / 90 % RH 500 h, no voltage applied | Capacitance change | -20 % to +40 % of initial value |
| | | Dissipation factor | Within initial limit |
| | | Leakage current | Shall not exceed 300 % of initial limit |
| Stability at low and high temperatures | -55 °C | Capacitance change | Within -20 % to 0 % of initial value |
| | | Dissipation factor | Shall not exceed 150 % of initial limit |
| | | Leakage current | n/a |
| | 25 °C | Capacitance change | Within ± 20 % of initial value |
| | | Dissipation factor | Within initial limit |
| | | Leakage current | Within initial limit |
| | 105 °C | Capacitance change | Within -50 % to +30 % of initial value |
| | | Dissipation factor | Within initial limits |
| | | Leakage current | Shall not exceed 1000 % of initial limits |
| Surge voltage | 85 °C, 1000 successive test cycles at 1.3 of rated voltage in series with a 1 kΩ resistor at the rate of 30 s ON, 30 s OFF | Capacitance change | Within ± 20 % of initial value |
| | | Dissipation factor | Within initial limit |
| | | Leakage current | Shall not exceed 300 % of initial limit |
| Shock (specified pulse) | MIL-STD-202, method 213, condition I, 100 g peak | Capacitance change | Within ± 20 % of initial value |
| | | Dissipation factor | Within initial limit |
| | | Leakage current | Shall not exceed 300 % of initial limit |
| Vibration | MIL-STD-202, method 204, condition D, 10 Hz to 2000 Hz 20 g peak | There shall be no mechanical or visual damage to capacitors post-conditioning. | |
| Shear test | Apply a pressure load of 5 N for 10 s ± 1 s horizontally to the center of capacitor side body | Capacitance change | Within ± 20 % of initial value |
| | | Dissipation factor | Within initial limit |
| | | Leakage current | Shall not exceed 300 % of initial limit |

| PRODUCT INFORMATION | |
|----------------------------|--|
| Polymer Guide | www.vishay.com/doc?40076 |
| Moisture Sensitivity | www.vishay.com/doc?40135 |
| Infographic | www.vishay.com/doc?48084 |
| Sample Board | www.vishay.com/doc?48073 |
| FAQ | |
| Frequently Asked Questions | www.vishay.com/doc?42106 |



Guide for Tantalum Solid Electrolyte Chip Capacitors with Polymer Cathode

INTRODUCTION

Tantalum electrolytic capacitors are the preferred choice in applications where volumetric efficiency, stable electrical parameters, high reliability, and long service life are primary considerations. The stability and resistance to elevated temperatures of the tantalum/tantalum oxide/manganese dioxide system make solid tantalum capacitors an appropriate choice for today's surface mount assembly technology.

Vishay Sprague has been a pioneer and leader in this field, producing a large variety of tantalum capacitor types for consumer, industrial, automotive, military, and aerospace electronic applications.

Tantalum is not found in its pure state. Rather, it is commonly found in a number of oxide minerals, often in combination with Columbium ore. This combination is known as "tantalite" when its contents are more than one-half tantalum. Important sources of tantalite include Australia, Brazil, Canada, China, and several African countries. Synthetic tantalite concentrates produced from tin slags in Thailand, Malaysia, and Brazil are also a significant raw material for tantalum production.

Electronic applications, and particularly capacitors, consume the largest share of world tantalum production. Other important applications for tantalum include cutting tools (tantalum carbide), high temperature super alloys, chemical processing equipment, medical implants, and military ordnance.

Vishay Sprague is a major user of tantalum materials in the form of powder and wire for capacitor elements and rod and sheet for high temperature vacuum processing.

THE BASICS OF TANTALUM CAPACITORS

Most metals form crystalline oxides which are non-protecting, such as rust on iron or black oxide on copper. A few metals form dense, stable, tightly adhering, electrically insulating oxides. These are the so-called "valve" metals and include titanium, zirconium, niobium, tantalum, hafnium, and aluminum. Only a few of these permit the accurate control of oxide thickness by electrochemical means. Of these, the most valuable for the electronics industry are aluminum and tantalum.

Capacitors are basic to all kinds of electrical equipment, from radios and television sets to missile controls and automobile ignitions. Their function is to store an electrical charge for later use.

Capacitors consist of two conducting surfaces, usually metal plates, whose function is to conduct electricity. They are separated by an insulating material or dielectric. The dielectric used in all tantalum electrolytic capacitors is tantalum pentoxide.

Tantalum pentoxide compound possesses high-dielectric strength and a high-dielectric constant. As capacitors are being manufactured, a film of tantalum pentoxide is applied to their electrodes by means of an electrolytic process. The film is applied in various thicknesses and at various voltages and although transparent to begin with, it takes on different colors as light refracts through it. This coloring occurs on the tantalum electrodes of all types of tantalum capacitors.

Rating for rating, tantalum capacitors tend to have as much as three times better capacitance/volume efficiency than aluminum electrolytic capacitors. An approximation of the capacitance/volume efficiency of other types of capacitors may be inferred from the following table, which shows the dielectric constant ranges of the various materials used in each type. Note that tantalum pentoxide has a dielectric constant of 26, some three times greater than that of aluminum oxide. This, in addition to the fact that extremely thin films can be deposited during the electrolytic process mentioned earlier, makes the tantalum capacitor extremely efficient with respect to the number of microfarads available per unit volume. The capacitance of any capacitor is determined by the surface area of the two conducting plates, the distance between the plates, and the dielectric constant of the insulating material between the plates.

| COMPARISON OF CAPACITOR DIELECTRIC CONSTANTS | |
|--|-----------------------------------|
| DIELECTRIC | ϵ DIELECTRIC CONSTANT |
| Air or vacuum | 1.0 |
| Paper | 2.0 to 6.0 |
| Plastic | 2.1 to 6.0 |
| Mineral oil | 2.2 to 2.3 |
| Silicone oil | 2.7 to 2.8 |
| Quartz | 3.8 to 4.4 |
| Glass | 4.8 to 8.0 |
| Porcelain | 5.1 to 5.9 |
| Mica | 5.4 to 8.7 |
| Aluminum oxide | 8.4 |
| Tantalum pentoxide | 26 |
| Ceramic | 12 to 400K |

In the tantalum electrolytic capacitor, the distance between the plates is very small since it is only the thickness of the tantalum pentoxide film. As the dielectric constant of the tantalum pentoxide is high, the capacitance of a tantalum capacitor is high if the area of the plates is large:

$$C = \frac{\epsilon A}{t}$$

where

C = capacitance

ϵ = dielectric constant

A = surface area of the dielectric

t = thickness of the dielectric

Tantalum capacitors contain either liquid or solid electrolytes. In solid electrolyte capacitors, a dry material (manganese dioxide) forms the cathode plate. A tantalum lead is embedded in or welded to the pellet, which is in turn connected to a termination or lead wire. The drawings show the construction details of the surface mount types of tantalum capacitors shown in this catalog.

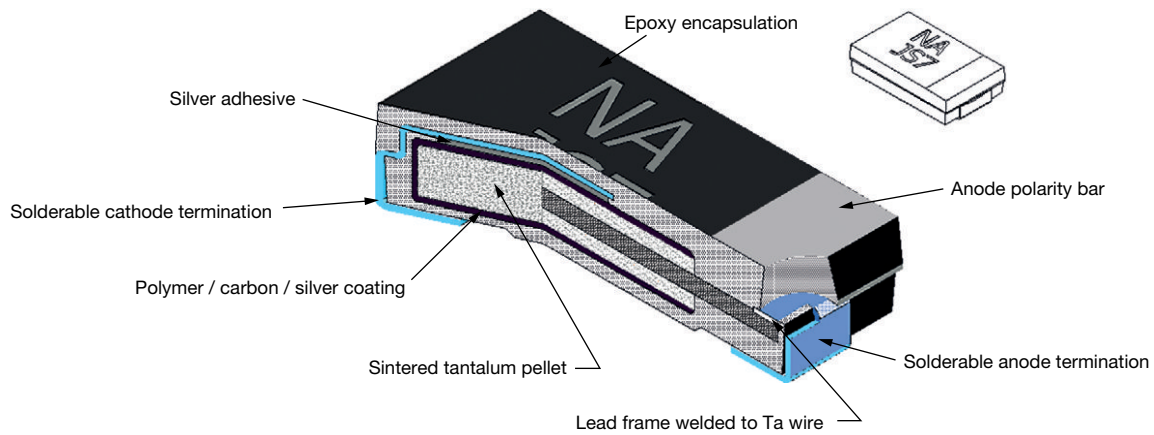
SOLID ELECTROLYTE POLYMER TANTALUM CAPACITORS

Solid electrolyte polymer capacitors utilize sintered tantalum pellets as anodes. Tantalum pentoxide dielectric layer is formed on the entire surface of anode, which is further impregnated with highly conductive polymer as cathode system.

The conductive polymer layer is then coated with graphite, followed by a layer of metallic silver, which provides a conductive surface between the capacitor element and the outer termination (lead frame or other).

Molded chip polymer tantalum capacitor encases the element in plastic resins, such as epoxy materials. After assembly, the capacitors are tested and inspected to assure long life and reliability. It offers excellent reliability and high stability for variety of applications in electronic devices. Usage of conductive polymer cathode system provides very low equivalent series resistance (ESR), which makes the capacitors particularly suitable for high frequency applications.

TANTALUM CAPACITOR WITH POLYMER CATHODE TYPE T55



TANTALUM CAPACITOR WITH POLYMER CATHODE TYPE T58



TANTALUM CAPACITOR WITH POLYMER CATHODE TYPE T52



TANTALUM CAPACITOR WITH POLYMER CATHODE TYPE T54 / T59

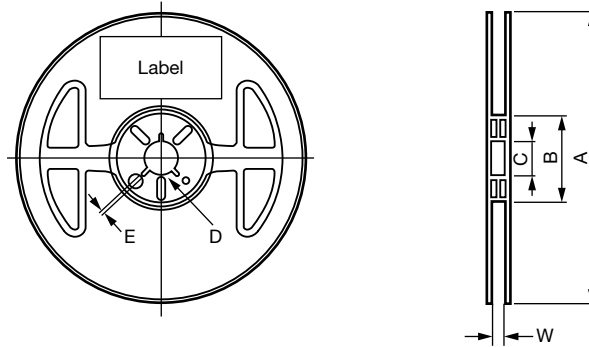


| POLYMER CAPACITORS - MOLDED CASE | |
|----------------------------------|---|
| SERIES | T55 |
| PRODUCT IMAGE | |
| TYPE | VPolyTan™, molded case, high performance polymer |
| FEATURES | High performance |
| TEMPERATURE RANGE | -55 °C to +105 °C |
| CAPACITANCE RANGE | 3.3 μF to 1000 μF |
| VOLTAGE RANGE | 2.5 V to 63 V |
| CAPACITANCE TOLERANCE | ± 20 % |
| LEAKAGE CURRENT | 0.1 CV |
| DISSIPATION FACTOR | 8 % to 10 % |
| ESR | 12 mΩ to 500 mΩ |
| CASE SIZES | J, P, A, T, B, Z, V, D |
| TERMINATION FINISH | Cases J, P: 100 % tin Case A: 100 % tin or Ni / Pd / Au Cases T, B, Z, V, D: Ni / Pd / Au |

| POLYMER CAPACITORS - LEADFRAMELESS MOLDED CASE | | | | |
|--|---|---|---|---|
| SERIES | T52 | T58 | T59 | T54 |
| PRODUCT IMAGE | | | | |
| TYPE | vPolyTan™ polymer surface mount chip capacitors, low profile, leadframeless molded type | vPolyTan™ polymer surface mount chip capacitors, compact, leadframeless molded type | vPolyTan™ polymer surface mount chip capacitors, low ESR, leadframeless molded type | vPolyTan™ polymer surface mount chip capacitors, low ESR, leadframeless molded type, hi-rel commercial off-the-shelf (COTS) |
| FEATURES | Low profile | Small case size | Multianode | Hi-rel COTS, multianode |
| TEMPERATURE RANGE | -55 °C to +105 °C | -55 °C to +105 °C | -55 °C to +105 °C | -55 °C to +125 °C |
| CAPACITANCE RANGE | 47 μF to 1500 μF | 1 μF to 330 μF | 15 μF to 470 μF | 15 μF to 470 μF |
| VOLTAGE RANGE | 10 V to 35 V | 6.3 V to 35 V | 16 V to 75 V | 16 V to 75 V |
| CAPACITANCE TOLERANCE | ± 20 % | ± 20 % | ± 10 %, ± 20 % | ± 20 % |
| LEAKAGE CURRENT | 0.1 CV | | | |
| DISSIPATION FACTOR | 10 % | 8 % to 14 % | 10 % | 10 % |
| ESR | 25 mΩ to 55 mΩ | 50 mΩ to 500 mΩ | 25 mΩ to 150 mΩ | 25 mΩ to 150 mΩ |
| CASE SIZES | E5, M1 | MM, M0, W0, W9, A0, AA, B0, BB | EE | EE |
| TERMINATION | 100 % tin | | 100 % tin / lead | |

MOLDED CAPACITORS, T55 TYPE

PLASTIC TAPE AND REEL PACKAGING DIMENSIONS in millimeters

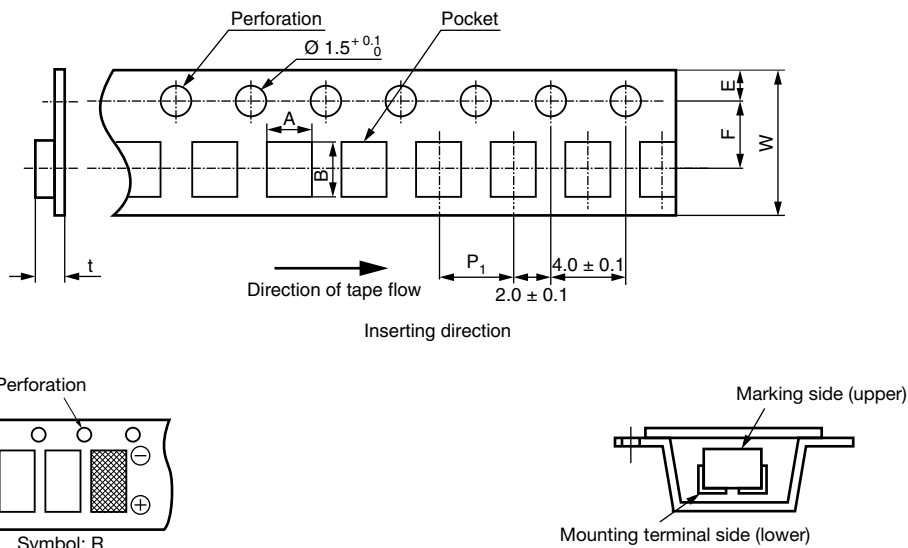


| TAPE WIDTH | 8 | 12 |
|-------------|-----|-------|
| A + 0 / - 3 | | Ø 180 |
| B + 1 / 0 | | Ø 60 |
| C ± 0.2 | | Ø 13 |
| D ± 0.5 | | Ø 21 |
| E ± 0.5 | | 2.0 |
| W ± 0.3 | 9.0 | 13.0 |

Note

- A reel diameter of 330 mm is also applicable

PLASTIC TAPE SIZE DIMENSIONS in millimeters

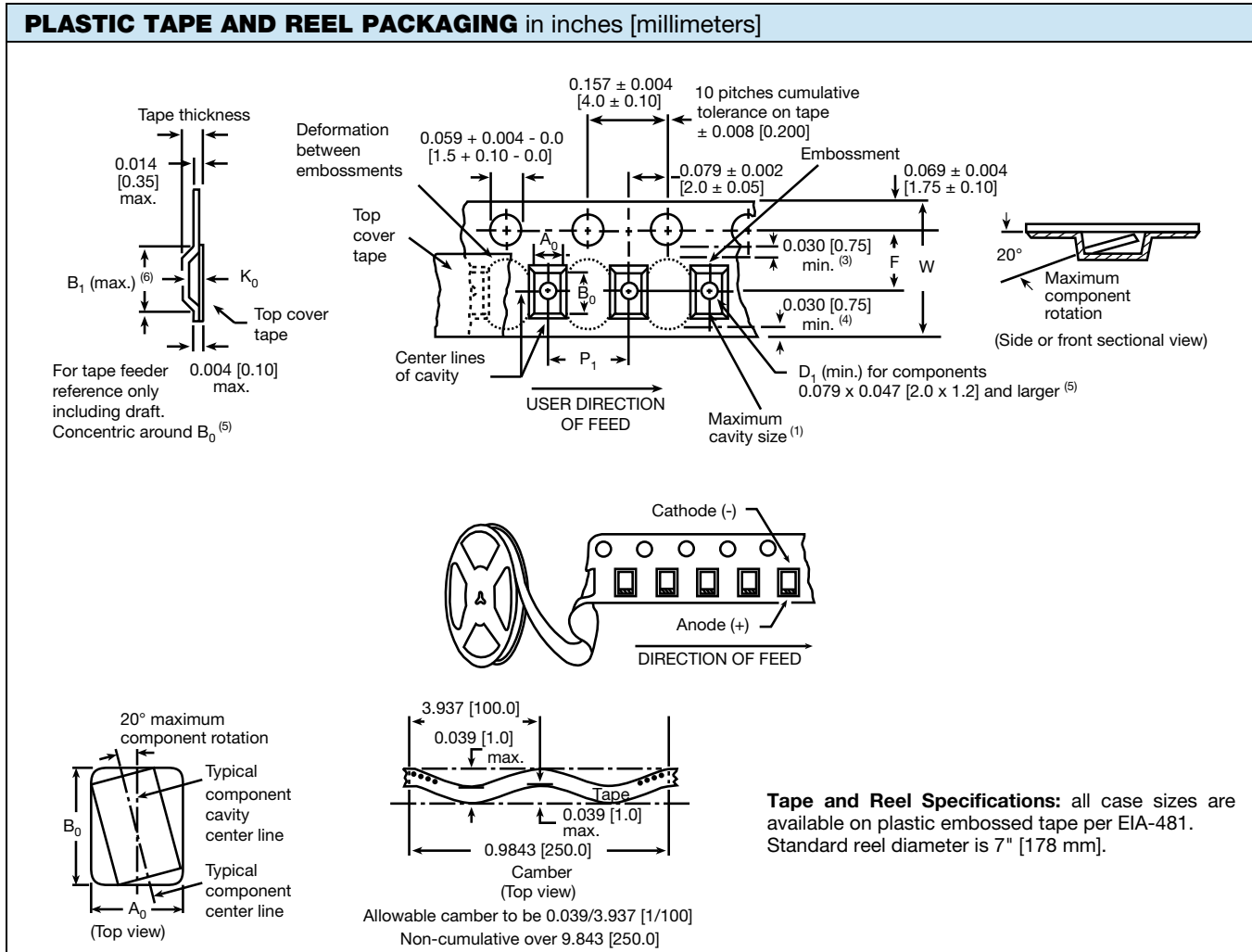


| CASE CODE | A ± 0.2 | B ± 0.2 | W ± 0.3 | F ± 0.1 | E ± 0.1 | P ₁ ± 0.1 | t _{max.} |
|-----------|---------|---------|---------|---------|---------|----------------------|-------------------|
| J | 1.0 | 1.8 | 8.0 | 3.5 | 1.75 | 4.0 | 1.3 |
| P | 1.4 | 2.2 | 8.0 | 3.5 | 1.75 | 4.0 | 1.6 |
| A | 1.9 | 3.5 | 8.0 | 3.5 | 1.75 | 4.0 | 2.5 |
| T | 3.1 | 3.8 | 8.0 | 3.5 | 1.75 | 4.0 | 1.7 |
| B | 3.1 | 3.8 | 8.0 | 3.5 | 1.75 | 4.0 | 2.5 |
| Z | 4.8 | 7.7 | 12.0 | 5.5 | 1.75 | 8.0 | 2.6 |
| V | 4.8 | 7.7 | 12.0 | 5.5 | 1.75 | 8.0 | 2.6 |
| D | 4.8 | 7.7 | 12.0 | 5.5 | 1.75 | 8.0 | 3.4 |

Note

- A reel diameter of 330 mm is also applicable

LEADFRAMELESS MOLDED CAPACITORS, ALL TYPES



Notes

- Metric dimensions will govern. Dimensions in inches are rounded and for reference only.
- ⁽¹⁾ A_0 , B_0 , K_0 , are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A_0 , B_0 , K_0) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°.
- ⁽²⁾ Tape with components shall pass around radius "R" without damage. The minimum trailer length may require additional length to provide "R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum.
- ⁽³⁾ This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less.
- ⁽⁴⁾ This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier tape between the embossed cavity or to the edge of the cavity whichever is less.
- ⁽⁵⁾ The embossed hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location shall be applied independent of each other.
- ⁽⁶⁾ B_1 dimension is a reference dimension tape feeder clearance only.

| CARRIER TAPE DIMENSIONS in inches [millimeters] | | | | | | | |
|--|-----------|--------------------------------------|-----------------------|--------------------------------|-----------------------|-------------------------------|--|
| CASE CODE | TAPE SIZE | B ₁ (MAX.) ⁽¹⁾ | D ₁ (MIN.) | F | K ₀ (MAX.) | P ₁ | W |
| E5 | 12 mm | 0.329 [8.35] | 0.059 [1.5] | 0.217 ± 0.002 [5.50 ± 0.05] | 0.071 [1.8] | 0.315 ± 0.004 [8.0 ± 0.10] | 0.476 ± 0.008 [12.1 ± 0.20] |
| MM ⁽²⁾ | 8 mm | 0.075 [1.91] | 0.02 [0.5] | 0.138 [3.5] | 0.043 [1.10] | 0.157 [4.0] | 0.315 [8.0] |
| M1 | 12 mm | 0.32 [8.2] | 0.059 [1.5] | 0.217 ± 0.002 [5.5 ± 0.05] | 0.094 [2.39] | 0.315 ± 0.04 [8.0 ± 1.0] | 0.472 + 0.012 / - 0.004 [12.0 + 0.3 / - 0.10] |
| W9 | 8 mm | 0.126 [3.20] | 0.030 [0.75] | 0.138 [3.5] | 0.045 [1.15] | 0.157 [4.0] | 0.315 [8.0] |
| W0 | 8 mm | 0.126 [3.20] | 0.030 [0.75] | 0.138 [3.5] | 0.045 [1.15] | 0.157 [4.0] | 0.315 [8.0] |
| A0 | 8 mm | - | 0.02 [0.5] | 0.138 [3.5] | 0.049 [1.25] | 0.157 [4.0] | 0.315 [8.0] |
| AA | 8 mm | 0.154 [3.90] | 0.039 [1.0] | 0.138 [3.5] | 0.079 [2.00] | 0.157 [4.0] | 0.315 [8.0] |
| B0 | 12 mm | 0.181 [4.61] | 0.059 [1.5] | 0.217 [5.5] | 0.049 [1.25] | 0.157 [4.0] | 0.315 [8.0] |
| BB | 8 mm | 0.157 [4.0] | 0.039 [1.0] | 0.138 [3.5] | 0.087 [2.22] | 0.157 [4.0] | 0.315 [8.0] |
| EE | 12 mm | 0.32 [8.2] | 0.059 [1.5] | 0.217 ± 0.002 [5.5 ± 0.05] | 0.175 [4.44] | 0.315 ± 0.04 [8.0 ± 1.0] | 0.472 + 0.012 / - 0.004 [12.0 + 0.3 / - 0.10] |

Notes

- (1) For reference only
- (2) Standard packaging of MM case is with paper tape. Plastic tape is available per request

| PAPER TAPE AND REEL PACKAGING DIMENSIONS in inches [millimeters] | | | | | | | | | | | |
|---|-----------|--------------------------------|--------------------------------|-----------------------------|------------------------------|------------------------------|-------------------------------|-------------------------------|--------------------------------|------------------------------|--------------------------------|
| | | | | | | | | | | | |
| CASE SIZE | TAPE SIZE | A ₀ | B ₀ | D ₀ | P ₀ | P ₁ | P ₂ | E | F | W | T |
| MM | 8 mm | 0.041 ± 0.002 [1.05 ± 0.05] | 0.071 ± 0.002 [1.8 ± 0.05] | 0.06 ± 0.004 [1.5 ± 0.1] | 0.157 ± 0.004 [4.0 ± 0.1] | 0.157 ± 0.004 [4.0 ± 0.1] | 0.079 ± 0.002 [2.0 ± 0.05] | 0.069 ± 0.004 [1.75 ± 0.1] | 0.0138 ± 0.002 [3.5 ± 0.05] | 0.315 ± 0.008 [8.0 ± 0.2] | 0.037 ± 0.002 [0.95 ± 0.05] |
| M0 | 8 mm | 0.049 ± 0.002 [1.25 ± 0.05] | 0.081 ± 0.002 [2.05 ± 0.05] | 0.06 ± 0.004 [1.5 ± 0.1] | 0.157 ± 0.004 [4.0 ± 0.1] | 0.157 ± 0.004 [4.0 ± 0.1] | 0.079 ± 0.002 [2.0 ± 0.05] | 0.069 ± 0.004 [1.75 ± 0.1] | 0.0138 ± 0.002 [3.5 ± 0.05] | 0.315 ± 0.008 [8.0 ± 0.2] | 0.041 ± 0.002 [1.05 ± 0.05] |

Note

- (1) A₀, B₀ are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°

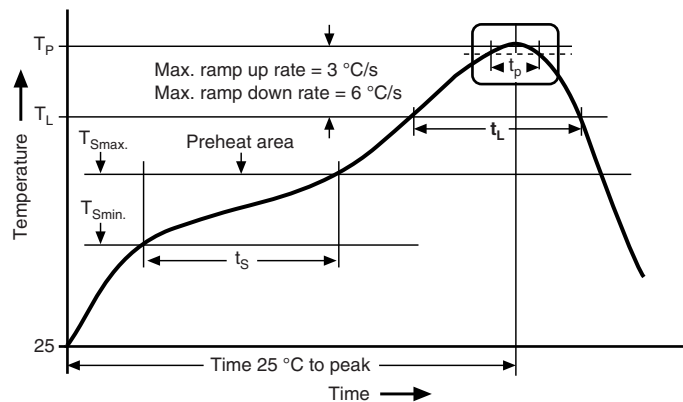
PACKING AND STORAGE

Polymer capacitors meet moisture sensitivity level rating (MSL) of 3 or 4 as specified in IPC/JEDEC® J-STD-020 and are dry packaged in moisture barrier bags (MBB) per J-STD-033. Standard Ratings table defines MSL level for each particular family. Level 3 specifies a floor life (out of bag) of 168 hours and level 4 specifies a floor life of 72 hours at 30 °C maximum and 60 % relative humidity (RH). Unused capacitors should be re-sealed in the MBB with fresh desiccant. A moisture strip (humidity indicator card) is included in the bag to assure dryness. To remove excess moisture, capacitors can be dried at 40 °C (standard “dry box” conditions).

For detailed recommendations please refer to J-STD-033.

RECOMMENDED REFLOW PROFILES

Vishay recommends no more than 3 cycles of reflow in accordance with J-STD-020.



| PROFILE FEATURE | SnPb EUTECTIC ASSEMBLY | LEAD (Pb)-FREE ASSEMBLY |
|---|--|-------------------------|
| PREHEAT AND SOAK | | |
| Temperature min. ($T_{Smin.}$) | 100 °C | 150 °C |
| Temperature max. ($T_{Smax.}$) | 150 °C | 200 °C |
| Time (t_s) from ($T_{Smin.}$ to $T_{Smax.}$) | 60 s to 120 s | 60 s to 120 s |
| RAMP UP | | |
| Ramp-up rate (T_L to T_p) | 3 °C/s maximum | |
| Liquidus temperature (T_L) | 183 °C | 217 °C |
| Time (t_L) maintained above T_L | 60 s to 150 s | |
| Peak package body temperature (T_p) max. | Depends on type and case - see table below | |
| Time (t_p) within 5 °C of the peak max. temperature | 20 s | 5 s |
| RAMP DOWN | | |
| Ramp-down rate (T_p to T_L) | 6 °C/s maximum | |
| Time from 25 °C to peak temperature | 6 min maximum | 8 min maximum |

PEAK PACKAGE BODY TEMPERATURE (T_p) MAXIMUM

| TYPE | CASE CODE | PEAK PACKAGE BODY TEMPERATURE (T_p) MAX. | |
|------|--------------------------------|--|-------------------------|
| | | SnPb EUTECTIC ASSEMBLY | LEAD (Pb)-FREE ASSEMBLY |
| T55 | J, P, A, T, B, Z, V, D | n/a | 260 °C |
| T52 | E5, M1 | | 260 °C |
| T58 | MM, M0, W9, W0, A0, AA, B0, BB | | 260 °C |
| T59 | EE | 220 °C | 250 °C |
| T54 | EE | 220 °C | 250 °C |

Notes

- T52, T55, and T58 capacitors are process sensitive. PSL classification to JEDEC J-STD-075: R4G
- T54 and T59 capacitors with 100 % tin termination are process sensitive. PSL classification to JEDEC J-STD-075: R6G

MOLDED CAPACITORS, T55 TYPE

| PAD DIMENSIONS in millimeters | | | | | | |
|-------------------------------|----------------|------|----------------|----------|----------|----------|
| | | | | | | |
| CASE / DIMENSIONS | CAPACITOR SIZE | | PAD DIMENSIONS | | | |
| | L | W | G (max.) | Z (min.) | X (min.) | Y (Ref.) |
| J | 1.6 | 0.8 | 0.7 | 2.5 | 1.0 | 0.9 |
| P | 2.0 | 1.25 | 0.5 | 2.6 | 1.2 | 1.05 |
| A | 3.2 | 1.6 | 1.1 | 3.8 | 1.5 | 1.35 |
| T / B | 3.5 | 2.8 | 1.4 | 4.1 | 2.7 | 1.35 |
| Z / V / D | 7.3 | 4.3 | 4.1 | 8.2 | 2.9 | 2.05 |

LEADFRAMELESS MOLDED CAPACITORS, ALL TYPES

| PAD DIMENSIONS in inches [millimeters] | | | | | |
|--|------------|--------------|--------------|--------------|--------------|
| | | | | | |
| FAMILY | CASE CODE | A (NOM.) | B (MIN.) | C (NOM.) | D (MIN.) |
| T52 | E5 | 0.094 [2.40] | 0.073 [1.85] | 0.187 [4.75] | 0.333 [8.45] |
| | M1 | 0.161 [4.10] | 0.073 [1.85] | 0.187 [4.75] | 0.333 [8.45] |
| T58 | MM, M0 | 0.024 [0.61] | 0.027 [0.70] | 0.025 [0.64] | 0.080 [2.03] |
| | W0, W9 | 0.035 [0.89] | 0.029 [0.74] | 0.041 [1.05] | 0.099 [2.52] |
| | AA, A0, A2 | 0.047 [1.19] | 0.042 [1.06] | 0.065 [1.65] | 0.148 [3.76] |
| | BB, B0 | 0.094 [2.39] | 0.044 [1.11] | 0.072 [1.82] | 0.159 [4.03] |
| T59 / T54 | EE | 0.209 [5.30] | 0.098 [2.50] | 0.169 [4.30] | 0.366 [9.30] |

GUIDE TO APPLICATION

1. **AC Ripple Current:** the maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = power dissipation in W at +45 °C as given in the tables in the product datasheets.

R_{ESR} = the capacitor equivalent series resistance at the specified frequency.

2. **AC Ripple Voltage:** the maximum allowable ripple voltage shall be determined from the formula:

$$V_{RMS} = Z \sqrt{\frac{P}{R_{ESR}}}$$

or, from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

where,

P = power dissipation in W at +45 °C as given in the tables in the product datasheets.

R_{ESR} = The capacitor equivalent series resistance at the specified frequency.

Z = The capacitor impedance at the specified frequency.

- 2.1 The tantalum capacitors must be used in such a condition that the sum of the working voltage and ripple voltage peak values does not exceed the rated voltage as shown in figure below.



3. **Temperature Derating:** power dissipation is affected by the heat sinking capability of the mounting surface. If these capacitors are to be operated at temperatures above +45 °C, the permissible ripple current (or voltage) shall be calculated using the derating coefficient as shown in the table below:

| MAXIMUM RIPPLE CURRENT TEMPERATURE DERATING FACTOR | |
|--|-----|
| ≤ 45 °C | 1.0 |
| 55 °C | 0.8 |
| 85 °C | 0.6 |
| 105 °C | 0.4 |

4. **Reverse Voltage:** the capacitors are not intended for use with reverse voltage applied. However, they are capable of withstanding momentary reverse voltage peaks, which must not exceed the following values:
At 25 °C: 10 % of the rated voltage or 1 V, whichever is smaller.

At 85 °C: 5 % of the rated voltage or 0.5 V, whichever is smaller.

At 105 °C: 3 % of the rated voltage or 0.3 V, whichever is smaller.

5. **Mounting Precautions:**

- 5.1 **Limit Pressure on Capacitor Installation with Mounter:** pressure must not exceed 4.9 N with a tool end diameter of 1.5 mm when applied to the capacitors using an absorber, centering tweezers, or similar (maximum permitted pressurization time: 5 s). An excessively low absorber setting position would result in not only the application of undue force to the capacitors but capacitor and other component scattering, circuit board wiring breakage, and / or cracking as well, particularly when the capacitors are mounted together with other chips having a height of 1 mm or less.

- 5.2 **Flux Selection**

5.2.1 Select a flux that contains a minimum of chlorine and amine.

5.2.2 After flux use, the chlorine and amine in the flux remain must be removed.

- 5.3 **Cleaning After Mounting:** the following solvents are usable when cleaning the capacitors after mounting. Never use a highly active solvent.

- Halogen organic solvent (HCFC225, etc.)
- Alcoholic solvent (IPA, ethanol, etc.)
- Petroleum solvent, alkali saponifying agent, water, etc.

Circuit board cleaning must be conducted at a temperature of not higher than 50 °C and for an immersion time of not longer than 30 minutes. When an ultrasonic cleaning method is used, cleaning must be conducted at a frequency of 48 kHz or lower, at an vibrator output of 0.02 W/cm³, at a temperature of not higher than 40 °C, and for a time of 5 minutes or shorter.

Notes

- Care must be exercised in cleaning process so that the mounted capacitor will not come into contact with any cleaned object or the like or will not get rubbed by a stiff brush or similar. If such precautions are not taken particularly when the ultrasonic cleaning method is employed, terminal breakage may occur.
- When performing ultrasonic cleaning under conditions other than stated above, conduct adequate advance checkout.



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



Телефон: 8 (812) 309-75-97 (многоканальный)

Факс: 8 (812) 320-03-32

Электронная почта: ocean@oceanchips.ru

Web: <http://oceanchips.ru/>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А